

94A, 100V N-CHANNEL MOSFET

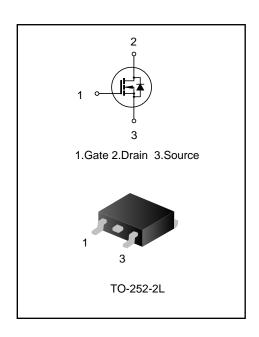
DESCRIPTION

SVGQ109R5NAD is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance and high avalanche breakdown tolerance.

This device is widely used in power management for UPS and Inverter Systems.

FEATURES

- 94A, 100V, R_{DS(on)(typ.)}=7.2mΩ@V_{GS}=10V
- Low gate charge
- Low Crss
- Fast switching
- Extreme dv/dt rated
- 100% avalanche tested
- Pb-free lead plating
- · RoHS compliant
- Max. junction temperature: T_{imax} = 175 °C



KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V _{DS}	100	V
V _{GS(th)}	1.4~2.4	V
R _{DS(on),max}	9.5	mΩ
I _D	94	A
Q _{g.typ}	49	nC

ORDERING INFORMATION

Part No.	Package	Marking Hazard Substance		Packing Type
SVGQ109R5NADTR	TO-252-2L	Q109R5NA	Halogen free	Tape & Reel

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

Characteristics	Cumbal	Test conditions	Ratings			Unit
Characteristics	Symbol	rest conditions	Min.	Тур. Мах.		Offic
Drain-source Voltage	V_{DS}		100			V
Gate-source Voltage	V_{GS}		-20		20	V
Drain Current (Note 1)		T _C =25°C			94	_
Drain Current (Note 1)	Ι _D	T _C =100°C			66	Α
Drain Current Pulsed (Note 2)	I _{DM}	T _C =25°C			376	Α
Power Dissipation (Note 3)	P _D	T _C =25°C			107	W
Single Pulsed Avalanche	_	L=0.5mH, V_{DD} =80V, R_{G} =25 Ω ,			240	mJ
Energy	E _{AS}	starting temperature T _J =25°C				
Single Pulsed Avalanche	I _{AS}				31	Α
Current	IAS				31	A
Operation Junction	т.	T _J 55	55		175	°C
Temperature Range	IJ		-35			
Storage Temperature Range	T _{stg}		-55		175	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Тур.	Max.	Oilit
Thermal Resistance,	$R_{ heta JC}$				1.4	°C/W
Junction-case, Bottom						
Thermal Resistance,	В	D			62.0	°C/W
Junction-ambient	$R_{ hetaJA}$				02.0	-0///
Soldering Temperature(SMD)	T _{sold}	Reflow soldering: 10±1 sec, 3times			260	°C

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ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, TJ=25°C)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
Characteristics		rest conditions	Min.	Тур.	Max.	Offic
Drain-source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250µA	100	-	-	٧
Drain-source Leakage Current	I	V _{DS} =100V, V _{GS} =0V, T _J =25°C	1	1	1.0	μА
	I _{DSS}	V _{DS} =100V, V _{GS} =0V, T _J =125°C		3.0		
Gate-source Leakage Current	I _{GSS}	$V_{GS}=\pm20V$, $V_{DS}=0V$	1	1	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_{D}=250\mu A$	1.4		2.4	V
Static Drain-source	D	V _{GS} =10V, I _D =39A		7.2	9.5	m()
On State Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =39A		9.5	13.5	mΩ
Gate Resistance	R_g	f=1MHz		1.9		Ω

Dynamic characteristics

Chamastanistics	Comple at	Took condikions	Ratings			1.1
Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Input Capacitance	C _{iss}			3321		
Output Capacitance	C _{oss}	f=1MHz, V _{GS} =0V, V _{DS} =50V		390		pF
Reverse Transfer Capacitance	C _{rss}			7.2		
Turn-on Delay Time	t _{d(on)}	V 50V V 40V D 470		15		
Turn-on Rise Time	t _r	V_{DD} =50V, V_{GS} =10V, R_{G} =4.7 Ω ,		33		
Turn-off Delay Time	$t_{d(off)}$	I _D =39A (Notes 4. 5)		51		ns
Turn-off Fall Time	t _f	(Notes 4, 5)		12		
Total Gate Charge	Q_g			49		
Gate-source Charge	Q_{gs}	V _{DD} =50V, V _{GS} =10V, I _D =39A		14		nC
Gate-drain Charge	Q_{gd}	(Notes 4, 5)		7.0		
Gate-plateau Voltage	V _{plateau}			4.0		V

Reverse diode characteristics

Characteristics	Symbol Test conditions		Ratings			Unit
Offaracteristics	Symbol	rest conditions	Min.	Тур.	Max.	Oill
Continuous Diode Forward Current	Is	Integral reverse P-N junction			94	۸
Diode Pulse Current	I _{S,pulse}	diode in the MOSFET			376	А
Source-Drain Diode Voltage Drop	V _{SD}	I _S =78A, V _{GS} =0V			1.4	V
Reverse Recovery Time	T _{rr}	I _S =12A, V _{GS} =0V, V _R =50V,		64		ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt=100A/μs (Note 4)		115		nC

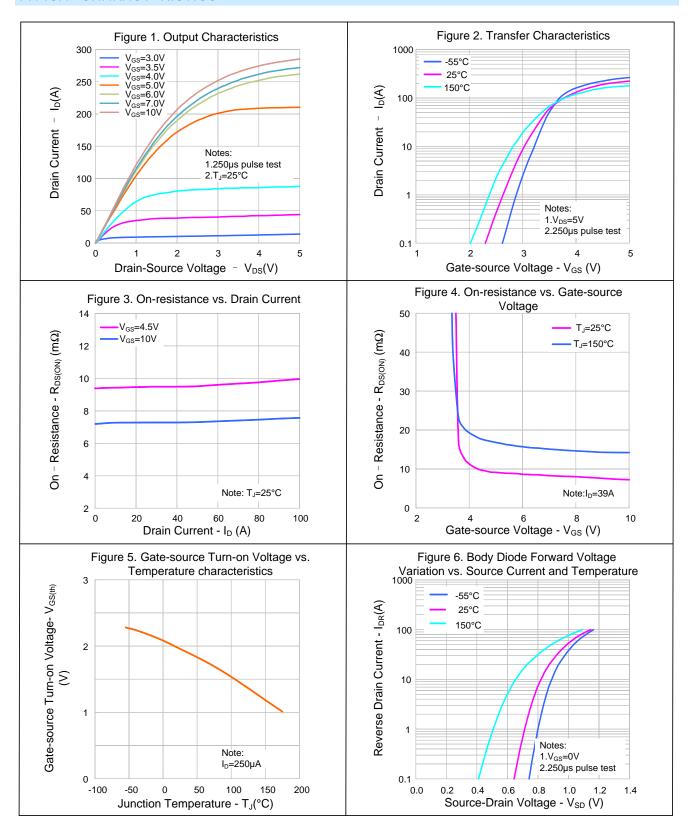
Notes:

- 1. The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C, it should be derated according to the actual environmental conditions
- 2. Pulse time 5µs:
- 3. The dissipation power will change with temperature, derating above 25°C: 0.71W/°C;
- 4. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
- 5. Essentially independent of operating temperature.

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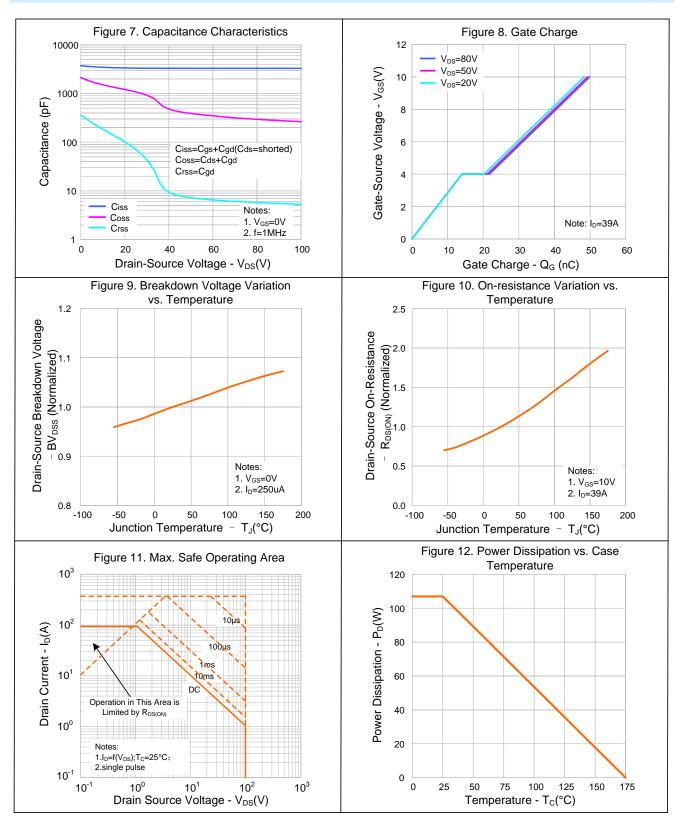
TYPICAL CHARACTERISTICS



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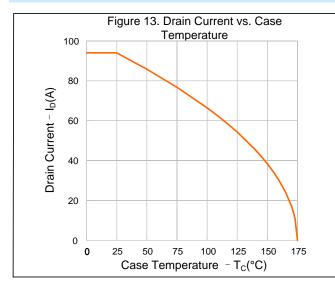
TYPICAL CHARACTERISTICS (CONTINUED)

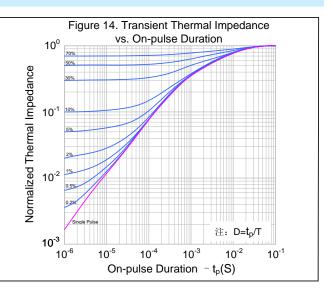


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TYPICAL CHARACTERISTICS (CONTINUED)



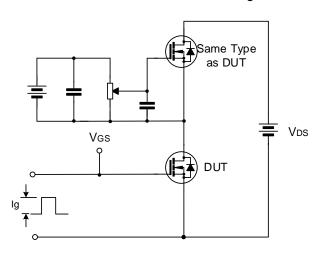


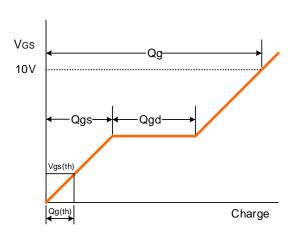
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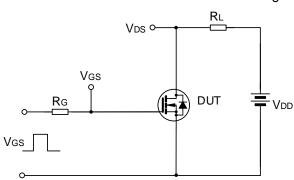
TYPICAL TEST CIRCUIT

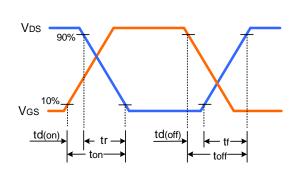
Gate Charge Test Circuit & Waveform



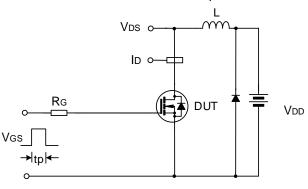


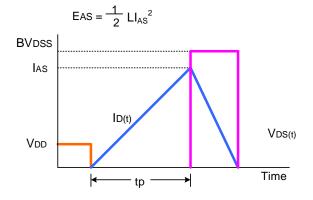
Resistive Switching Test Circuit & Waveform





Unclamped Inductive Switching Test Circuit & Waveform

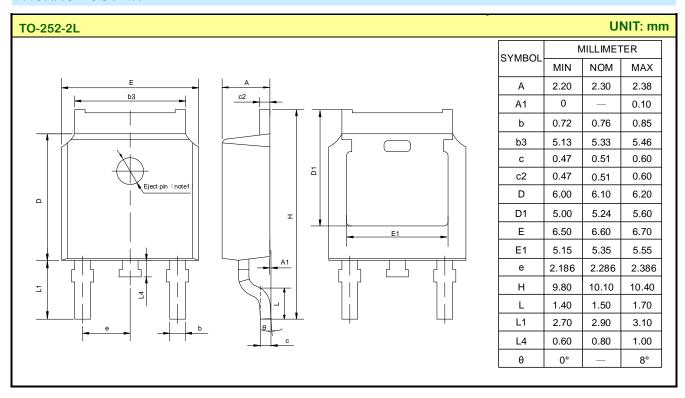




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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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Rev.: 1.1

Revision History:

1. Delete the wave soldering condition

2. Add Figure 13

3. Update the typical test circuit

4. Update the package outline

5. Update the important notice

Rev.: 1.0

Revision History:

1. First release

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